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Understanding <u>Embedded - FPGAs (Field</u> <u>Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	2304
Total RAM Bits	18432
Number of I/O	161
Number of Gates	50000
Voltage - Supply	3V ~ 3.6V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C
Package / Case	208-BFQFP
Supplier Device Package	208-PQFP (28x28)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/at40k40al-1dqc

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong



able 1.	AT40KAL	Family ⁽¹⁾
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Device	AT40K05AL	AT40K10AL	AT40K20AL	AT40K40AL
Usable Gates	5K - 10K	10K - 20K	20K - 30K	40K - 50K
Rows x Columns	16 x 16	24 x 24	32 x 32	48 x 48
Cells	256	576	1,024	2,304
Registers	496 ⁽¹⁾	954 ⁽¹⁾	1,520 ⁽¹⁾	3,048 ⁽¹⁾
RAM Bits	2,048	4,608	8,192	18,432
I/O (Maximum)	128	192	256	384

Note: 1. Packages with FCK will have 8 less registers.

Description

The AT40KAL is a family of fully PCI-compliant, SRAM-based FPGAs with distributed 10 ns programmable synchronous/asynchronous, dual-port/single-port SRAM, 8 global clocks, Cache Logic ability (partially or fully reconfigurable without loss of data), automatic component generators, and range in size from 5,000 to 50,000 usable gates. I/O counts range from 128 to 384 in industry standard packages ranging from 84-pin PLCC to 352-ball Square BGA, and support 3.3V designs.

The AT40KAL is designed to quickly implement high-performance, large gate count designs through the use of synthesis and schematic-based tools used on a PC or Sun platform. Atmel's design tools provide seamless integration with industry standard tools such as Synplicity, ModelSim, Exemplar and Viewlogic. See the "IDS Datasheet" available on the Atmel web site (http://www.atmel.com/atmel/acrobat/doc1421.pdf) for a list of other supported tools.

The AT40KAL can be used as a coprocessor for high-speed (DSP/processor-based) designs by implementing a variety of computation intensive, arithmetic functions. These include adaptive finite impulse response (FIR) filters, fast Fourier transforms (FFT), convolvers, interpolators and discrete-cosine transforms (DCT) that are required for video compression and decompression, encryption, convolution and other multimedia applications.

- Fast, Flexible and
Efficient SRAMThe AT40KAL FPGA offers a patented distributed 10 ns SRAM capability where the
RAM can be used without losing logic resources. Multiple independent, synchronous or
asynchronous, dual-port or single-port RAM functions (FIFO, scratch pad, etc.) can be
created using Atmel's macro generator tool.
- **Fast, Efficient Array and Vector Multipliers** The AT40KAL's patented 8-sided core cell with direct horizontal, vertical and diagonal cell-to-cell connections implements ultra fast array multipliers without using any busing resources. The AT40KAL's Cache Logic capability enables a large number of design coefficients and variables to be implemented in a very small amount of silicon, enabling vast improvement in system speed at much lower cost than conventional FPGAs.

Cache Logic Design The AT40KAL, AT6000 and FPSLIC families are capable of implementing Cache Logic (dynamic full/partial logic reconfiguration, without loss of data, on-the-fly) for building adaptive logic and systems. As new logic functions are required, they can be loaded into the logic cache without losing the data already there or disrupting the operation of the rest of the chip; replacing or complementing the active logic. The AT40KAL can act as a reconfigurable coprocessor.

Automatic Component Generators The AT40KAL FPGA family is capable of implementing user-defined, automatically generated, macros in multiple designs; speed and functionality are unaffected by the macro orientation or density of the target device. This enables the fastest, most predictable and efficient FPGA design approach and minimizes design risk by reusing already proven functions. The Automatic Component Generators work seamlessly with industry standard schematic and synthesis tools to create the fastest, most efficient designs available.

The patented AT40KAL series architecture employs a symmetrical grid of small yet powerful cells connected to a flexible busing network. Independently controlled clocks and resets govern every column of cells. The array is surrounded by programmable I/O.

Devices range in size from 5,000 to 50,000 usable gates in the family, and have 256 to 3,048 registers. Pin locations are consistent throughout the AT40KAL series for easy design migration in the same package footprint. The AT40KAL series FPGAs utilize a reliable 0.35µ triple-metal, CMOS process and are 100% factory-tested. Atmel's PC-and workstation-based integrated development system (IDS) is used to create AT40KAL series designs. Multiple design entry methods are supported.

The Atmel architecture was developed to provide the highest levels of performance, functional density and design flexibility in an FPGA. The cells in the Atmel array are small, efficient and can implement any pair of Boolean functions of (the same) three inputs or any single Boolean function of four inputs. The cell's small size leads to arrays with large numbers of cells, greatly multiplying the functionality in each cell. A simple, high-speed busing network provides fast, efficient communication over medium and long distances.





Figure 2. Floor Plan (Representative Portion)⁽¹⁾

- Note:
- Repeaters regenerate signals and can connect any bus to any other bus (all pathways are legal) on the same plane. Each repeater has connections to two adjacent local-bus segments and two express-bus segments. This is done automatically using the integrated development system (IDS) tool.





The Busing Network

Figure 3 on page 7 depicts one of five identical busing planes. Each plane has three bus resources: a local-bus resource (the middle bus) and two express-bus (both sides) resources. Bus resources are connected via repeaters. Each repeater has connections to two adjacent local-bus segments and two express-bus segments. Each local-bus segment spans four cells and connects to consecutive repeaters. Each express-bus segment spans eight cells and "leapfrogs" or bypasses a repeater. Repeaters regenerate signals and can connect any bus to any other bus (all pathways are legal) on the same plane. Although not shown, a local bus can bypass a repeater via a programmable pass gate allowing long on-chip tri-state buses to be created. Local/Local turns are implemented through pass gates in the cell-bus interface. Express/Express turns are implemented through separate pass gates distributed throughout the array.

Some of the bus resources on the AT40KAL are used as a dual-function resources. Table 2 shows which buses are used in a dual-function mode and which bus plane is used. The AT40KAL software tools are designed to accommodate dual-function buses in an efficient manner.

Function	Туре	Plane(s)	Direction	Comments
Cell Output Enable	Local	5	Horizontal and Vertical	
RAM Output Enable	Express	2	Vertical	Bus full length at array edge Bus in first column to left of RAM block
RAM Write Enable	Express	1	Vertical	Bus full length at array edge Bus in first column to left of RAM block
RAM Address	Express	1 - 5	Vertical	Buses full length at array edge Buses in second column to left of RAM block
RAM Data In	Local	1	Horizontal	Data In connects to local bus plane 1
RAM Data Out	Local	2	Horizontal	Data out connects to local bus plane 2
Clocking	Express	4	Vertical	Bus half length at array edge
Set/Reset	Express	5	Vertical	Bus half length at array edge

Table 2. Dual-function Buses

Figure 5. The Cell



- X = Diagonal Direct Connect or Bus
- Y = Orthogonal Direct Connect or Bus
- W = Bus Connection
- Z = Bus Connection
- FB = Internal Feedback





Set/Reset Scheme

The AT40KAL family reset scheme is essentially the same as the clock scheme except that there is only one Global Reset. A dedicated Global Set/Reset bus can be driven by any User I/O, except those used for clocking (Global Clocks or Fast Clocks). The automatic placement tool will choose the reset net with the most connections to use the global resources. You can change this by using an RSBUF component in your design to indicate the global reset. Additional resets will use the express bus network.

The Global Set/Reset is distributed to each column of the array. Like Sector Clock mux, there is Sector Set/Reset mux at every four cells. Each sector column of four cells is set/reset by a Plane 5 express bus or Global Set/Reset using the Sector Set/Reset mux, see Figure 11 on page 17. The set/reset provided to each sector column of four cells is either inverted or non-inverted using the Sector Reset mux.

The function of the Set/Reset input of a register is determined by a configuration bit in each cell. The Set/Reset input of a register is active low (logic 0) by default. Setting or Resetting of a register is asynchronous. Before configuration on power-up, a logic 1 (a high) is provided by each register (i.e., all registers are set at power-up).

Primary, Secondary and	The AT40KAL has three kinds of I/Os: Primary I/O, Secondary I/O and a Corner I/O.
Corner I/Os	Every edge cell except corner cells on the AT40KAL has access to one Primary I/O and two Secondary I/Os.

Primary I/O Every logic cell at the edge of the FPGA array has a direct orthogonal connection to and from a Primary I/O cell. The Primary I/O interfaces directly to its adjacent core cell. It also connects into the repeaters on the row immediately above and below the adjacent core cell. In addition, each Primary I/O also connects into the busing network of the three nearest edge cells. This is an extremely powerful feature, as it provides logic cells toward the center of the array with fast access to I/Os via local and express buses. It can be seen from the diagram that a given Primary I/O can be accessed from any logic cell on three separate rows or columns of the FPGA. See Figure 12 on page 20.

- Secondary I/O Every logic cell at the edge of the FPGA array has two direct diagonal connections to a Secondary I/O cell. The Secondary I/O is located between core cell locations. This I/O connects on the diagonal inputs to the cell above and the cell below. It also connects to the repeater of the cell above and below. In addition, each Secondary I/O also connects into the busing network of the two nearest edge cells. This is an extremely powerful feature, as it provides logic cells toward the center of the array with fast access to I/Os via local and express buses. It can be seen from the diagram that a given Secondary I/O can be accessed from any logic cell on two rows or columns of the FPGA. See Figure 13 on page 20.
- **Corner I/O** Logic cells at the corner of the FPGA array have direct-connect access to five separate I/Os: 2 Primary, 2 Secondary and 1 Corner I/O. Corner I/Os are like an extra Secondary I/O at each corner of the array. With the inclusion of Corner I/Os, an AT40KAL FPGA with n x n core cells always has 8n I/Os. As the diagram shows, Corner I/Os can be accessed both from the corner logic cell and the horizontal and vertical busing networks running along the edges of the array. This means that many different edge logic cells can access the Corner I/Os. See Figure 14 on page 21.











Absolute Maximum Ratings – 3.3V Commercial/Industrial*

Operating Temperature55°C to +125°C
Storage Temperature65 °C to +150°C
Voltage on Any Pin with Respect to Ground0.5V to $\rm V_{\rm CC}$ +7V
Supply Voltage (V $_{\rm CC}$)0.5V to +7.0V
Maximum Soldering Temp. (10 sec. @ 1/16 in.)250°C
ESD (R _{ZAP} = 1.5K, C _{ZAP} = 100 pF)

*NOTICE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those listed under operating conditions is not implied. Exposure to Absolute Maximum Rating conditions for extended periods of time may affect device reliability.

DC and AC Operating Range – 3.3V Operation

		Commercial	Industrial	
Operating Temperature (Case)		0°C - 70°C	-40°C - 85°C	
V _{CC} Power Supply		3.3V ± 0.3V	3.3V ± 0.3V	
	High (V _{IHC})	70% - 100% V _{CC}	70% - 100% V _{CC}	
	Low (V _{ILC})	0 - 30% V _{CC}	0 - 30% V _{CC}	

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Power-On Power Supply Requirements

Atmel FPGAs require a minimum rated power supply current capacity to insure proper initialization, and the power supply ramp-up time does affect the current required. A fast ramp-up time requires more current than a slow ramp-up time.

Table 3. Power-On Power Supply Requirements⁽¹⁾

Device	Description	Maximum Current ⁽²⁾⁽³⁾
AT40K05AL AT40K10AL	Maximum Current Supply	50 mA
AT40K20AL AT40K40AL	Maximum Current Supply	100 mA

Notes: 1. This specification applies to Commercial and Industrial grade products only.

2. Devices are guaranteed to initialize properly at 50% of the minimum current listed above. A larger capacity power supply may result in a larger initialization current.

3. Ramp-up time is measured from 0 V DC to 3.6 V DC. Peak current required lasts less than 2 ms, and occurs near the internal power on reset threshold voltage.



AC Timing Characteristics – 3.3V Operation

Delays are based on fixed loads and are described in the notes. Maximum times based on worst case: $V_{CC} = 3.0V$, temperature = 70°C Minimum times based on best case: $V_{CC} = 3.6V$, temperature = 0°C

Cell Function	Parameter	Path	-1	Units	Notes
Async RAM					
Write	t _{WECYC} (Minimum)	cycle time	12.0	ns	
Write	t _{WEL} (Minimum)	we	5.0	ns	Pulse width low
Write	t _{WEH} (Minimum)	we	5.0	ns	Pulse width high
Write	t _{AWS} (Minimum)	wr addr setup -> we	5.3	ns	
Write	t _{AWH} (Minimum)	wr addr hold -> we	0.0	ns	
Write	t _{DS} (Minimum)	din setup -> we	5.0	ns	
Write	t _{DH} (Minimum)	din hold -> we	0.0	ns	
Write/Read	t _{DD} (Maximum)	din -> dout	8.7	ns	rd addr = wr addr
Read	t _{AD} (Maximum)	rd addr -> dout	6.3	ns	
Read	t _{ozx} (Maximum)	oe -> dout	2.9	ns	
Read	t _{oxz} (Maximum)	oe -> dout	3.5	ns	
Sync RAM					•
Write	t _{CYC} (Minimum)	cycle time	12.0	ns	
Write	t _{CLKL} (Minimum)	clk	5.0	ns	Pulse width low
Write	t _{CLKH} (Minimum)	clk	5.0	ns	Pulse width high
Write	t _{wcs} (Minimum)	we setup -> clk	3.2	ns	
Write	t _{WCH} (Minimum)	we hold -> clk	0.0	ns	
Write	t _{ACS} (Minimum)	wr addr setup -> clk	5.0	ns	
Write	t _{ACH} (Minimum)	wr addr hold -> clk	0.0	ns	
Write	t _{DCS} (Minimum)	wr data setup -> clk	3.9	ns	
Write	t _{DCH} (Minimum)	wr data hold -> clk	0.0	ns	
Write/Read	t _{CD} (Maximum)	clk -> dout	5.8	ns	rd addr = wr addr
Read	t _{AD} (Maximum)	rd addr -> dout	6.3	ns	
Read	t _{ozx} (Maximum)	oe -> dout	2.9	ns	
Read	t _{oxz} (Maximum)	oe -> dout	3.5	ns	

Notes: 1. CMOS buffer delays are measured from a V_{H} of 1/2 V_{CC} at the pad to the internal V_{H} at A. The input buffer load is constant. 2. Buffer delay is to a pad voltage of 1.5V with one output switching.

Builden delay is to a pad voltage of 1.50 with the output switching.
 Parameter based on characterization and simulation; not tested in production.

Exact power calculation is available in Atmel FPGA Designer software.

FreeRAM Asynchronous Timing Characteristics

Single-port Write/Read







Dual-port Read







AT40K05AL	AT40K10AL	AT40K20AL	AT40K40AL		Left Si	de (Top to B	ottom)	
128 I/O	192 I/O	256 I/O	384 I/O	84 PLCC	100 TQFP	144 LQFP	208 PQFP	240 PQFP
I/O9, FCK1	I/O13, FCK1	I/O17, FCK1	I/O25, FCK1			9	15	15
I/O10	I/O14	I/O18	I/O26			10	16	16
I/O11 (A20)	I/O15 (A20)	I/O19 (A20)	I/O27 (A20)	17	6	11	17	17
I/O12 (A21)	I/O16 (A21)	I/O20 (A21)	I/O28 (A21)	18	7	12	18	18
	VCC	VCC	VCC					19
	I/O17	I/O21	I/O29					20
	I/O18	I/O22	I/O30					21
			GND					
			I/O31					
			I/O32					
			I/O33					
			I/O34					
		I/O23	I/O35					
		I/O24	I/O36					
		GND	GND					22
			VCC					
			I/O37					
			I/O38					
		I/O25	I/O39					
		I/O26	I/O40					
	I/O19	I/O27	I/O41				19	23
	I/O20	I/O28	I/O42				20	24
			GND					
I/O13	I/O21	I/O29	I/O43			13	21	25
I/O14	I/O22	I/O30	I/O44		8	14	22	26
			I/O45					
			I/O46					
I/O15 (A22)	I/O23 (A22)	I/O31 (A22)	I/O47 (A22)	19	9	15	23	27
I/O16 (A23)	I/O24 (A23)	I/O32 (A23)	I/O48 (A23)	20	10	16	24	28
GND	GND	GND	GND	21	11	17	25	29
VCC	VCC	VCC	VCC	22	12	18	26	30
Note: 1 On	-chip tri-state	1	1	1		1		

AT40K05AL	AT40K10AL	AT40K20AL	AT40K40AL		Left Si	ide (Top to B	ottom)	
128 I/O	192 I/O	256 I/O	384 I/O	84 PLCC	100 TQFP	144 LQFP	208 PQFP	240 PQFP
I/O17	I/O25	I/O33	I/O49	23	13	19	27	31
I/O18	I/O26	I/O34	I/O50	24	14	20	28	32
			I/O51					
			I/O52					
I/O19	I/O27	I/O35	I/O53		15	21	29	33
I/O20	I/O28	I/O36	I/O54			22	Bottom)	34
			GND					
	I/O29	I/O37	I/O55				31	35
	I/O30	I/O38	I/O56				32	36
		I/O39	I/O57					
		I/O40	I/O58					
			I/O59					
			I/O60					
			VCC					
		GND	GND					37
		I/O41	I/O61					
		I/O42	I/O62					
			I/O63					
			I/O64					
			I/O65					
			I/O66					
			GND					
	I/O31	I/O43	I/O67					38
	I/O32	I/O44	I/O68					39
	VCC	VCC	VCC					40
I/O21	I/O33	I/O45	I/O69	25	16	23	33	41
I/O22	I/O34	I/O46	I/O70	26	17	24	34	42
I/O23	I/O35	I/O47	I/071			25	35	43
I/O24, FCK2	I/O36, FCK2	I/O48, FCK2	I/O72, FCK2			26	36	44
GND	GND	GND	GND			27	37	45
		I/O49	I/O73					
		I/O50	I/074					
	I/O37	I/O51	I/075					46
Note [.] 1 On	-chin tri-state	1	1	1	1	1		





AT40K05AL	AT40K10AL	AT40K20AL	AT40K40AL	Left Side (Top to Bottom)				
128 I/O	192 I/O	256 I/O	384 I/O	84 PLCC	100 TQFP	144 LQFP	208 PQFP	240 PQFP
	I/O38	I/O52	I/O76					47
			I/077					
			I/O78					
			GND					
			I/O79					
			I/O80					
	I/O39	I/O53	I/O81				38	48
	I/O40	I/O54	I/O82				39	49
I/O25	I/O41	I/O55	I/O83				40	50
I/O26	I/O42	I/O56	I/O84				41	51
		GND	GND					
		VCC	VCC					
		I/O57	I/O85					
		I/O58	I/O86					
			I/O87					
			I/O88					
I/O27	I/O43	I/O59	I/O89	27	18	28	42	52
I/O28	I/O44	I/O60	I/O90		19	29	43	53
			GND					
			I/O91					
			I/O92					
I/O29	I/O45	I/O61	I/O93			30	44	54
I/O30	I/O46	I/O62	I/O94			31	45	55
I/O31 (OTS) ⁽¹⁾	I/O47 (OTS) ⁽¹⁾	I/O63 (OTS) ⁽¹⁾	I/O95 (OTS) ⁽¹⁾	28	20	32	46	56
I/O32, GCK2	I/O48, GCK2	I/O64, GCK2	I/O96, GCK2	29	21	33	47	57
M1	M1	M1	M1	30	22	34	48	58
GND	GND	GND	GND	31	23	35	49	59
MO	MO	MO	MO	32	24	36	50	60
Note: 1. On	-chip tri-state							



AT40K05AL	AT40K10AL	AT40K20AL	AT40K40AL	Right Side (Bottom to Top)				
128 I/O	192 I/O	256 I/O	384 I/O	84 PLCC	100 TQFP	144 LQFP	208 PQFP	240 PQFP
I/O73, FCK3	I/O111, FCK3	I/O147, FCK3	I/O219, FCK3			82	120	138
I/074	I/O112	I/O148	I/O220			83	121	139
	VCC	VCC	VCC					140
l/O75 (D5)	I/O113 (D5)	I/O149 (D5)	I/O221 (D5)	59	57	84	122	141
I/O76 (CS0)	I/O114 (CS0)	I/O150 (CS0)	I/O222 (CS0)	60	58	85	123	142
			GND					
			I/O223					
			I/O224					
			I/O225					
			I/O226					
		I/O151	I/O227					
		I/O152	I/O228					
		GND	GND					143
			VCC					
			I/O229					
			I/O230					
		I/O153	I/O231					
		I/O154	I/O232					
	I/O115	I/O155	I/O233				124	144
	I/O116	I/O156	I/O234				125	145
			GND					
I/077	I/O117	I/O157	I/O235		59	86	126	146
I/O78	I/O118	I/O158	I/O236		60	87	127	147
			I/O237					
			I/O238					
I/O79(D4)	I/O119(D4)	I/O159(D4)	I/O239(D4)	61	61	88	128	148
I/O80	I/O120	I/O160	I/O240	62	62	89	129	149
VCC	VCC	VCC	VCC	63	63	90	130	150
GND	GND	GND	GND	64	64	91	131	151
I/O81 (D3)	I/O121 (D3)	I/O161 (D3)	I/O241 (D3)	65	65	92	132	152
I/O82 (CHECK)	I/O122 (CHECK)	I/O162 (CHECK)	I/O242 (CHECK)	66	66	93	133	153

AT40K05AL	AT40K10AL	AT40K20AL	AT40K40AL	Top Side (Right to Left)				
128 I/O	192 I/O	256 I/O	384 I/O	84 PLCC	100 TQFP	144 LQFP	208 PQFP	240 PQFP
GND	GND	GND	GND	76	77	110	160	182
I/O97 (A0)	I/O145 (A0)	I/O193 (A0)	I/O289 (A0)	77	78	111	161	183
I/O98, GCK7 (A1)	I/O146, GCK7 (A1)	I/O194, GCK7 (A1)	I/O290, GCK7 (A1)	78	79	112	162	184
I/O99	I/O147	I/O195	I/O291			113	163	185
I/O100	I/O148	I/O196	I/O292			114	164	186
			I/O293					
			I/O294					
			GND					
			I/O295					
			I/O296					
I/O101 (<u>CS1</u> ,A2)	I/O149 (CS1,A2)	I/O197 (CS1,A2)	I/O297 (CS1,A2)	79	80	115	165	187
I/O102 (A3)	I/O150 (A3)	I/O198 (A3)	I/O298 (A3)	80	81	116	166	188
		I/O199	I/O299					
		I/O200	I/O300					
		VCC	VCC					
		GND	GND					
	I/O151 ⁽¹⁾	I/O201 ⁽¹⁾	I/O301 ⁽¹⁾	75 ⁽¹⁾ NC	76 ⁽¹⁾ NC	109 ⁽¹⁾ NC	159 ⁽¹⁾ NC	189 ⁽¹⁾ NC
	I/O152	I/O202	I/O302					190
I/O103	I/O153	I/O203	I/O303			117	167	191
I/O104 ⁽¹⁾	I/O154	I/O204	I/O304				168	192
			I/O305					
			I/O306					
			GND					
			I/O307					
			I/O308					
	I/O155	I/O205	I/O309				169	193
	I/O156	I/O206	I/O310				170	194
		I/O207	I/O311					195
		I/O208	I/O312					
GND	GND	GND	GND			118	171	196
Note: 1. Sha	ared with TSTCLK	. No Connect.						

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AT40K05AL	AT40K10AL	AT40K20AL	AT40K40AL	Top Side (Right to Left)				
128 I/O	192 I/O	256 I/O	384 I/O	84 PLCC	100 TQFP	144 LQFP	208 PQFP	240 PQFP
I/O113 (A8)	I/O169 (A8)	I/O225 (A8)	I/O337 (A8)	3	90	129	184	213
I/O114 (A9)	I/O170 (A9)	I/O226 (A9)	I/O338 (A9)	4	91	130	185	214
			I/O339					
			I/O340					
			I/O341					
			I/O342					
			GND					
I/O115	I/O171	I/O227	I/O343		92	131	186	215
I/O116	I/O172	I/O228	I/O344		93	132	187	216
	I/O173	I/O229	I/O345				188	217
	I/O174	I/O230	I/O346				189	218
I/O117 (A10)	I/O175 (A10)	I/O231 (A10)	I/O347 (A10)	5	94	133	190	220
I/O118 (A11)	I/O176 (A11)	I/O232 (A11)	I/O348 (A11)	6	95	134	191	221
			VCC					
		GND	GND					
		I/O233	I/O349					
		I/O234	I/O350					
			I/O351					
			I/O352					
			I/O353					
			I/O354					
			GND					
		I/O235	I/O355					
		I/O236	I/O356					
	VCC	VCC	VCC					222
	I/O177	I/O237	I/O357					223
	I/O178	I/O238	I/O358					224
I/O119	I/O179	I/O239	I/O359			135	192	225
I/O120	I/O180	I/O240	I/O360			136	193	226
GND	GND	GND	GND			137	194	227
		I/O241	I/O361					
Note: 1. Sha	ared with TSTCL	K. No Connect.						



240Q1 – PQFP







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